

## <u>inger</u>

### Micro Xinger 3dB Hybrid Coupler

# 1178035

Very Low Loss High Isolation 90<sup>0</sup> Quadrature Surface Mountable Tape And Reel

Available in Lead-Free (as illustrated) or Tin-Lead

#### **Description**

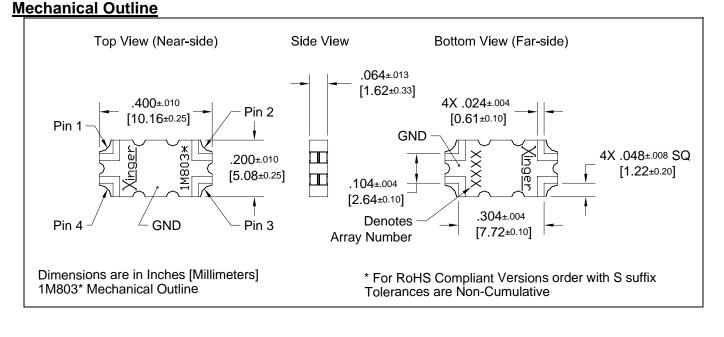
The 1M803 Micro Xinger® is a low profile, miniature 3dB hybrid coupler in an easy to use surface mount package designed for U-NII, ISM and hyper LAN applications. The 1M803 is designed for balanced amplifiers and signal distribution and is an ideal solution for the ever increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4 and G-10. Available in both 5 of 6 tin lead (1M803) and 6 of 6 RoHS compliant tin immersion (1M803S).

#### **ELECTRICAL SPECIFICATIONS\*\***

Frequency	Isolation	Insertion Loss	VSWR	
GHz	dB Min	dB Max	Max:1	
5.0 - 6.0 4.8 - 6.0	20 20	0.25 0.25	1.21 1.21	
Amplitude Balance	Phase Balance	Power	ΘJC	Operating Temp.
dB Max	Degrees	Ave. CW Watts	°C/Watt	°C
± 0.30 ± 0.40	± 3 ± 3.5	20	78.1	-55 to +85

\*\*Specification based on performance of unit properly installed on microstrip printed circuit boards with 50  $\Omega$  nominal impedance. Specifications subject to change without notice.

Features:



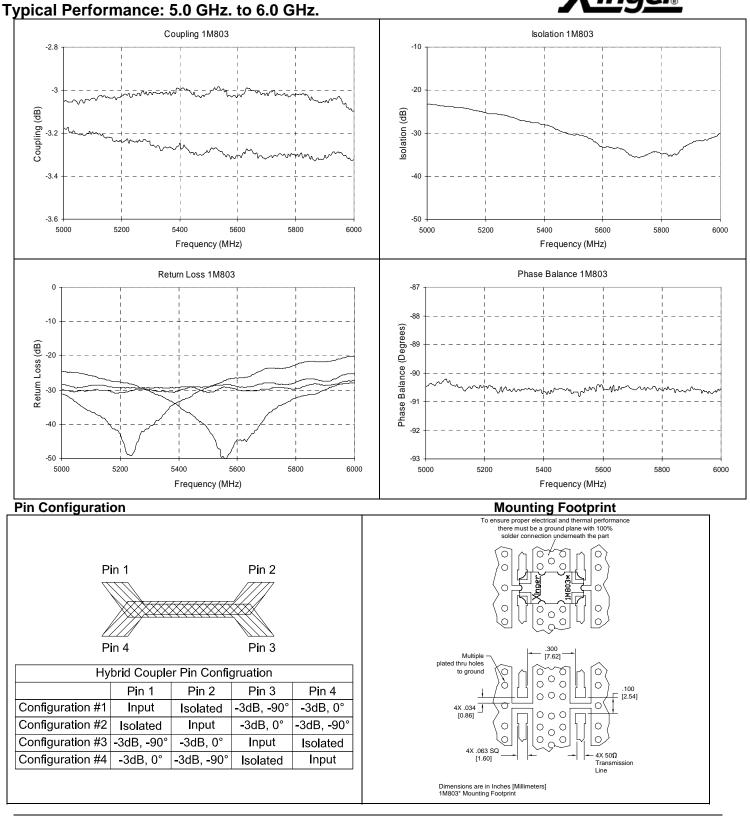




Available on Tape and Reel For Pick and Place Manufacturing. USA/Canada: (315) 432-8909 Toll Free: (800) 544-2414 Europe: +44 2392-232392



Xinger.



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#### PACKAGING

Packaging follows EIA-481-2. Parts are oriented in tape as shown below. Minimum order quantities are 2000 per reel and 48 per tube.

